12 V, 7.0 A, Low V_{CE(sat)} **NPN Transistor**

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage $(V_{\text{CE}(\text{sat})})$ and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

• This is a Pb-Free Device

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	12	Vdc
Collector-Base Voltage	V _{CBO}	12	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current - Continuous	I _C	5.0	Adc
Collector Current - Peak	I _{CM}	7.0	Α
Electrostatic Discharge	ESD	HBM Class 3B MM Class C	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 1)	875 7.0	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 1)	143	°C/W
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 2)	1.5 11.8	W mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 2)	85	°C/W
Thermal Resistance, Junction-to-Lead #1	R _{0JL} (Note 2)	23	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

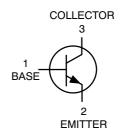
- FR-4 @ 100 mm², 1 oz copper traces.
 FR-4 @ 500 mm², 1 oz copper traces.



ON Semiconductor®

http://onsemi.com

12 VOLTS, 7.0 AMPS NPN LOW V_{CE(sat)} TRANSISTOR EQUIVALENT R_{DS(on)} 31 mΩ





WDFN3 **CASE 506AU**

MARKING DIAGRAM



= Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NSS12501UW3T2G	WDFN3 (Pb-Free)	3000/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Min	Typical	Max	Unit
l l		l		
V _(BR) CEO	12	-	-	Vdc
V _{(BR)CBO}	12	-	-	Vdc
V _{(BR)EBO}	6.0	-	-	Vdc
I _{CBO}	-	-	0.1	μAdc
ГЕВО	-	-	0.1	μAdc
h _{FE}	200 200 200 200 200 200	- - 345 330 315		
V _{CE(sat)}	- - - - -	0.007 0.031 0.045 0.070 0.100 0.100	0.008 0.035 0.060 0.100 0.120 0.120	V
V _{BE(sat)}	-	0.760	0.900	V
V _{BE(on)}	-	0.730	0.900	V
f _T	150	-	-	MHz
Cibo	-		650	pF
Cobo	-		120	pF
t _d	-	-	90	ns
t _r	-	-	100	ns
t _s	-	-	320	ns
t _f	-	-	100	ns
	V(BR)CEO V(BR)CBO V(BR)EBO ICBO IEBO VCE(sat) VBE(on) fT Cibo Cobo td tr ts	V(BR)CEO 12 V(BR)CBO 12 V(BR)EBO 6.0 ICBO - IEBO - NFE 200 200 200 200 200 200 200 200 VCE(sat) - VBE(sat) - VBE(sat) - VBE(sat) - t 150 Cibo - Cobo - t d - t r - t s -	V(BR)CEO 12	V(BR)CEO 12

^{3.} Pulsed Condition: Pulse Width = 300 $\mu sec,$ Duty Cycle \leq 2%.

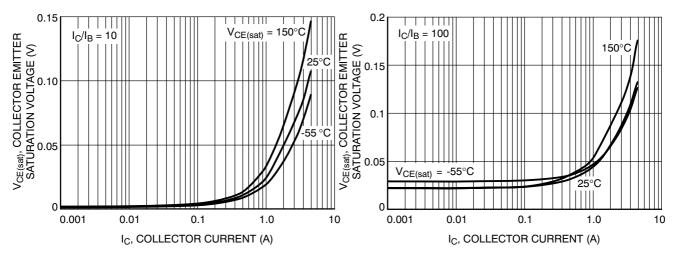


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

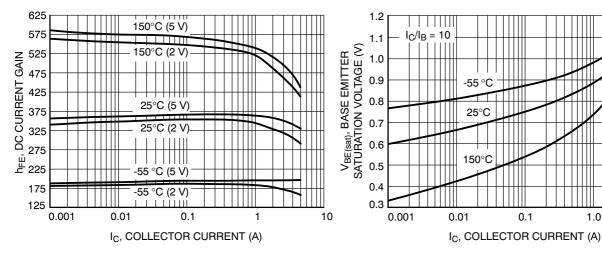


Figure 3. DC Current Gain vs. Collector Current

Figure 4. Base Emitter Saturation Voltage vs.
Collector Current

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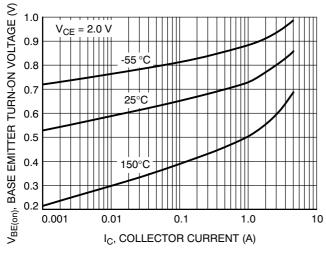


Figure 5. Base Emitter Turn-On Voltage vs. Collector Current

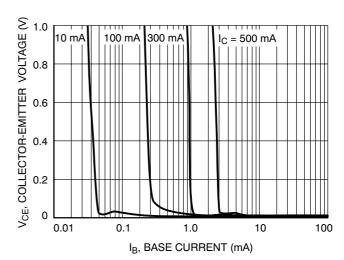
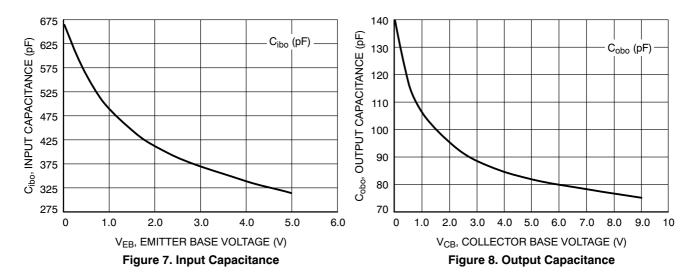


Figure 6. Saturation Region



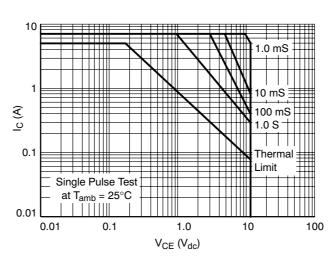


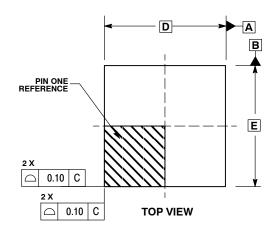
Figure 9. Safe Operating Area

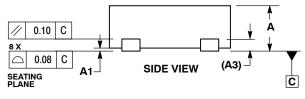


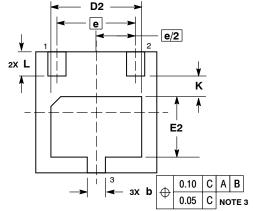
WDFN3 2x2, 1.3P CASE 506AU **ISSUE A**

DATE 18 AUG 2016

SCALE 4:1







BOTTOM VIEW

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994 .
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION b APPLIES TO PLATED TERMINAL AND IS

- MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS				INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00		0.05	0.000		0.002
A3		0.20 REF			0.008 REF	
b	0.25	0.30	0.35	0.010	0.012	0.014
D		2.00 BSC			0.079 BSC	;
D2	1.40	1.50	1.60	0.055	0.059	0.063
E		2.00 BSC			0.079 BSC	;
E2	0.90	1.00	1.10	0.035	0.039	0.043
е		1.30 BSC			0.051 BSC	;
K	0.35 REF 0.014 RE					
L	0.35	0.40	0.45	0.014	0.016	0.018

GENERIC MARKING DIAGRAM*

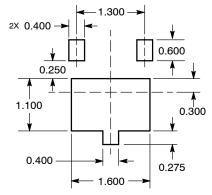


XX = Specific Device Code М = Date Code

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	WDFN3 2X2, 1.3P		PAGE 1 OF 1	

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